

RoHS

High Reliability Series Serial EEPROM Series I²C BUS Serial EEPROMS

BR24G

★BR24G01-3A, ★BR24G02-3A, ★BR24G04-3A, ★BR24G08-3A, ★BR24G16-3A, ★BR24G32-3A, ★BR24G64-3A, BR24G128-3A, BR24G256-3A, ★BR24G512-3A, ★BR24G1M-3A

★:BR24G01/02/04/08/16/32/64/512/1M-3A are model, the description matters are target all specifications because of the model under development.

ROHM's series of serial EEPROMs represent the highest level of reliability on the market. A double cell structure provides a failsafe method of data reliability, while a double reset function prevents data miswriting, pushing the boundaries of reliability to the limit.



BR24GDD-3A Series

Description

BR24G \square \square \neg 3A series is a serial EEPROM of I²C BUS interface method

Features

- · All controls available by 2 ports of serial clock(SCL) and serial data(SDA)
- · Other devices than EEPROM can be connected to the same port, saving microcontroller port
- 1.7V~5.5V single power source action most suitable for battery use
- 1.7V~5.5V wide limit of action voltage, possible 1MHz action
- · Page write mode useful for initial value write at factory shipment
- · Auto erase and auto end function at data write
- · Low current consumption
- · Write mistake prevention function
 - Write (write protect) function added
 - Write mistake prevention function at low voltage
- DIP-T8/SOP8/SOP-J8/SSOP-B8/TSSOP-B8/TSSOP-B8J/MSOP8/VSON008X2030 various package
- Data rewrite up to 1,000,000 times
- Data kept for 40 years
- Noise filter built in SCL / SDA terminal
- · Shipment data all address FFh

BR24G series

Capacity	Bit format	Туре	Power source Voltage	DIP-T8	SOF 8	SOP-J8	SSOP-B8	TSSOP-B8	TSSOP-B8J	MSOP8	VSON008 X2030
1Kbit	128×8	BR24G01-3A	1.7~5.5V	*	\ ☆\	*	* /	/ ☆	*	☆	*
2Kbit	256×8	BR24G02-3A	1.7~5.5V	☆	\☆ \	*	☆/	/ ☆	≯	☆	≯
4Kbit	512×8	BR24G04-3A	1.7~5.5V	≯	*	*	* /	*	*	☆	≯
8Kbit	1K×8	BR24G08-3A	1.7~5.5V	*	*	×	*	*	*	☆	*
16Kbit	2K×8	BR24G16-3A	1.7~5.5√	¥	\ ★	*	*	*	*	☆	≯
32Kbit	4K×8	BR24G32-3A	1.7 ~ 5.5V	*)) ☆	≯	*	*	*	☆	≯
64Kbit	8K×8	BR24G64-3A	1.7~5,5V	★ /	/ ☆	*	☆	*	*	☆	*
128Kbit	16K×8	BR24G128-3A	1.7~5.5V	•/	•	•7	•	•	•	•	•
256Kbit	32K×8	BR24G256-3A	(1.7~5.5∨		•	1	•	•			
512Kbit	64K×8	BR24G512-3A	1.7~5.5	√ ☆ ∕	☆	*	*	*			
1024Kbit	128K×8	BR24G1M-3A	1.7~5.5∨	*	*	*					

☆:Developing

BR24G

Technical Note

Absolute maximum ratings (Ta=25°C)

Parameter	symbol	Limits	Unit
Impressed voltage	V _{cc}	-0.3~+6.5	V
Permissible dissipation	Pd	450 (SOP8) ¹¹ 450 (SOP-J8) ¹² 300 (SSOP-B8) ¹³ 330 (TSSOP-B8) ¹⁴ 310 (TSSOP-B8J) ¹⁵	
		310 (MSOP8) ⁵ 300 (VSON008X2030) ^{*7} 800 (DIP-T8) ^{*8}	
Storage temperature range	Tstg	-65~+150	°C
Action temperature range	Topr	-40~+85	°C
Terminal voltage	-	-0.3~Vcc+1.0 ^{*9}	V
Junction Temperature *10	Tjmax	150	°C

When using at Ta=25°C or higher, 8.0mW(*8), 4.5mW(*1,*2),

3.0mW(*3,*7), 3.3mW(*4), 3.1mW(*5, *6) to be reduced per 1°C.

*9 The Max value of Terminal Voltage is not over 6.5V. When the pulse width is 50ns or less, the Min value of Terminal Voltage is not under -1.0V. (BR24G16/32/64/128/256/512/1M-3A) the Min value of Terminal Voltage is not under -0.8V. (BR24G01/02/04/08-3A)

*10 Junction temperature at the storage condition.

Electrical characteristics

(Unless otherwise specified, Ta=-40~+85°C, VCC=1.7~5.5V)

Doromotor	Complete	Limits			1 Junite	Conditions			
Farameter	Symbol	Min.	Тур.	Max.	Unit	Conditions			
"H" input voltage 1	V _{IH1}	0.7Vcc	-	Vcc+1.0	V				
"L" input voltage 1	VIL1	-0.311	-	0.3Vcc	V				
"L" output voltage 1	V _{OL1}	-	-	0.4	V	I _{OL} =3.0mA, 2.5V≦Vcc≦5.5V (SDA)			
"L" output voltage 2	Vol2	-	-	0.2	V	I _{OL} =0.7mA, 1.7V≦Vcc<2.5V (SDA)			
Input leak current	lu	-1	-	1	μA	V _{IN} =0~Vcc			
Output leak current	ILO	-1	-	1	μA	V _{OUT} =0~Vcc (SDA)			
		-	_	2.0	mA	Vcc=5.5V,f _{SCL} =400kHz, t _{WR} =5ms, Byte write, Page write BR24G01/02/04/08/16/32/64-3A			
	Icc1	Icc1	Icc1	Icc1	-	_	2.5	mA	Vcc=5.5V,f _{SCL} =400kHz, t _{WR} =5ms, Byte write, Page write BR24G128/256-3A
Current consumption		-	-	4.5	mA	Vcc=5.5V.f _{SCL} =400kHz, t _{WR} =5ms, Byte write, Page write BR24G512/1M-3A			
at action		-	_	0.5	mA	Vcc=5.5V.fscL=1MHz Random read, current read, sequential read BR24G01/102/04/08/16/32/64-3A			
	ICC2	-	-	2.0	mA	Vcc=6.5V.f _{sct} =1MHz Random read, current read, sequential read BR24G128/256/512/11/I-3A			
Standby current		-	-	2.0	μА	Vcc=5.5V, SDA • SCL=Vcc A0,A1,A2=GND,WP=GND BR24G01/02/04/08/16/32/64/128/256-3A			
Standby current	ISB	_	-	3.0	μΑ	Vcc=5.5V, SØA · SØL=Vcc A0,A1,A2=GND,VP=GND			

ORadiation resistance design is not made. *1 When the pulse width is 50ns or less, it is -1.0V. (BR24G16/32/64/128/256/512/1M-3A) When the pulse width is 50ns or less, it is -0.8V. (BR24G01/02/04/08-3A)

Sync data input / output timing



Memory cell characteristics (Ta=25°C, Vcc=1.7~5.5V)

		1 1 1 1 1 1 1			
Parameter	Min.	Тур.	Max	Unit	
Number of data rewrite times ^{*1}	1,000,000	_		Times	
Data hold years ^{*1}	40	_		Years	

Not 100% TESTED

Recommended operating conditions

-	- / /	
Parameter	Symbol Limits	Unit
Power source voltage	Vcc 1.7~5.5	
Input voltage	V _{IN} 0~Vcc	V

♦ AC OPERATING CHARACTERISTICS

	(Unless otherwise specified, Ta=	-40~+	-85°C,	vcc=		5.5V)	
	Parameter	Symbol		Unit			
	Varaineter	Symbol	Min.	Тур.	Max.	Unit	
	SCL frequency	fSCL	١	١	1000	kHz	
	Data clock "HIGH" time	tHIGH	0.3	I	-	μs	
	Data clock "LOW" time	tLOW	0.5	-	-	μs	
	SDA and SCL rise time	/tR /		I	0.12	μs	
	SDA and SCL fail time 1	tF1/	١	١	0.12	μs	
	SDA (OUT) fall time	tF2		-	0.12	μs	
	Start condition hold time	HD:STA	0.25	I	-	μs	
	Start-condition setup time	tSU:STA	0.25	١	-	μs	
	Input data hold time	tHD:DAT	0	-	-	μs	
	Input data setup time	tSU:DAT	50	-	-	ns	
	Output data delay time	tPD	0.05	I	0.45	μs	
	Output data hold time	tDH	0.05	١	-	μs	
	Stop condition setup time	tSU:STO	0.25	-	-	μs	
	Bus release time before ransfer start	tBUF	0.5	I		μs	
	Internal write cycle time	tWR		-	5	ms	
	Noise removal valid period (SDA, SCL terminal)	tl	-	-	0.05	μs	
\backslash	WP hold time	tHD:WP	1.0	-	-	μs	
	WP setup time	tSU:WP	0.1	-	-	μs	
	WP valid time	tHIGH:WP	1.0	-	—	μs	

*1 Not 100% TESTED.

●AC TIMING CHARACTERISTICS CONDITION

Parameter	Symbol	Condition	Unit
Load Capacitance	CL	100	pF
SDA and SCL rise time	tR	20	ns
SDA and SCL fall time	tF1	20	ns
Input Data Level	VIL/VIH	0.2Vcc/0.8Vcc	V
Input/Output Data Timing Refence Level	-	0.3Vcc/0.7Vcc	V



Fig.1-(d) WP timing at write execution



Fig.1-(e) WP timing at write cancel

Block diagram



Terminal	Input/	BR24G01-3A	BR24G02-3A	BR24G04-3A	BR24	G08-3	BR24G16-3A	BR24G32/64/128/256/5/2-3A	BR24G1M-3A
Name	Output	512100107	2.12.10.02.071	2.12.1001.071	51121				5121011101
A0	Input	Slave address	s setting		Don't use *			Slave address setting	Don't use *
A1	Input	Slave address setting Don't use *				Slave address setting			
A2	Input	Slave address setting Don't use * /					Slave address setting		
GND	_	Reference voltage of all input / output, 0							
SDA	Input/ output		Serial data input serial data output						
SCL	Input	Serial clock input							
WP	Input	Write protect terminal							
Vcc	_		Connect the power source.						

* Pins not used as device address may be set to any of 'H', 'L', and 'Hi-Z'.







•Characteristic data (The following values are Typ. ones.)



•Characteristic data (The following values are Typ. ones.)



●I²C BUS communication

OI²C BUS data communication

I²C BUS data communication starts by start condition input, and ends by stop condition input. Data is always 8bit long, and acknowledge is always required after each byte. I²C BUS carries out data transmission with plural devices connected by 2 communication lines of serial data (SDA) and serial clock (SCL).

Among devices, there are "master" that generates clock and control communication start and end, and "slave" that is controlled by address peculiar to devices. EEPROM becomes "slave". And the device that outputs data to bus during data communication is called "transmitter", and the device that receives data is called "receiver".



OStart condition (Start bit recognition)

- Before executing each command, start condition (start bit) where SDA goes from 'HIGH' down to 'LOW' when SCL is 'HIGH' is necessary.
- This IC always detects whether SDA and SCL are in start condition (start bit) or not, therefore, unless this condition is satisfied, any command is executed.

OStop condition (stop bit recongnition)

· Each command can be ended by SDA rising from 'LOW' to 'HIGH' when stop condition (stop bit), namely, SCL is 'HIGH'

OAcknowledge (ACK) signal

- This acknowledge (ACK) signal is a software rule to show whether data transfer has been made normally or not. In master and slave, the device (μ -COM at slave address input of write command, read command, and this IC at data output of read command) at the transmitter (sending) side releases the bus after output of 8bit data.
- The device (this IC at slave address input of write command, read command, and μ-COM at data output of read command) at the receiver (receiving) side sets SDA 'LOW' during 9 clock cycles, and outputs acknowledge signal (ACK signal) showing that it has received the 8bit data.
- . This IC, after recognizing start condition and slave address (8bit), outputs acknowledge signal (ACK signal) 'LOW'.
- Each write action outputs acknowledge signal (ACK signal) 'LOW', af receiving 8bit data (word address and write data).
 Each read action outputs 8bit data (read data), and detects acknowledge signal (ACK signal) 'LOW'. When acknowledge signal (ACK signal) is detected, and stop condition is not sent from the master (µ -COM) side, this IC continues data output. When acknowledge signal (ACK signal) is not detected, this IC stops data transfer, and recognizes stop condition (stop bit), and ends read action. And this IC gets in status.

ODevice addressing

- · Output slave address after start condition from master.
- The significant 4 bits of slave address are used for recognizing a device type.
- The device code of this IC is fixed to 1010'.
- Next slave addresses (A2 A1 A0 --- device address) are for selecting devices, and plural ones can be used on a same bus according to the number of device addresses.
- The most insignificant bit (R/W --- READ / WRITE) of slave address is used for designating write or read action, and is as shown below.

Setting R / \overline{w} to 0 ------ write (setting 0 to word address setting of random read) Setting R / \overline{w} to 1 ------ read

Туре	Slave address	Maximum number of Connected buses
BR24G01-3A,BR24G02-3A	1/0/1 0 A2 A1 A0 R/W	8
BR24G04-3A	√1 ∕0 1 0 A2 A1 P0 R/₩	4
BR24G08-3A	1 0 1 0 A2 P1 P0 R/W	2
BR24G16-3A	1 0 1 0 P2 P1 P0 R/W	1
BR24G32-3A, BR24G64-3A, BR24G128-3A,BR24G256-3A, BR24G512-3A	1 0 1 0 A2 A1 A0 R/W	8
BR24G1M-3A	1 0 1 0 A2 A1 P0 R/\overline{W}	4

P0~P2 are page select bits

•Write Command

OWrite cycle

• Arbitrary data is written to EEPROM. When to write only 1 byte, byte write is normally used, and when to write continuous data of 2 bytes or more, simultaneous write is possible by page write cycle. The maximum number of write bytes is specified per device of each capacity. up to 256 arbitrary bytes can be written. (In the case of BR24G1M-3A)



- During internal write execution, all input commands are ignored, therefore ACK is not sent back.
- Data is written to the address designated by word address (n-th address)
- By issuing stop bit after 8bit data input, write to memory cell inside starts.
- · When internal write is started, command is not accepted for tWR (5ms at maximum).

• By page write cycle, the following can be written in bulk :

Up to 8Byte (BR24G01-3A, BR24G02-3A) Up to 16Byte (BR24G04-3A, BR24G08-3A, BR24G16-3A) Up to 32Byte (BR24G32-3A, BR24G64-3A) Up to 64Byte (BR24G128-3A, BR24G256-3A) Up to 128Byte (BR24G512 -3A) Up to 256Byte (BR24G1M-3A)

And when data of the maximum bytes or higher is sent, data from the first byte is overwritten. (Refer to "Internal address increment" of "Notes on page write cycle" in P10.)

- As for page write cycle of BR24G01-3A and BR24G02-3A, after the significant 4 bits (in the case of BR24G01-3A) of word address, or the significant 5 bits (in the case of BR24G02-3A) of word address are designated arbitrarily by continuing data input of 2 bytes or more, the address of insignificant 3 bits is incremented internally, and data up to 8 bytes can be written.
- As for page write command of BR24G04-3A, BR24G08-3A and BR24G16-3A, after page select bit 'P0'(in the case of BR24G04-3A), after page select bit 'P0,P1'(in the case of BR24G08-3A), after page select bit 'P0,P1,P2'(in the case of BR24G16-3A) of slave address are designated arbitrarily, by continuing data input of 2 bytes or more, the address of insignificant 4 bits is incremented internally, and data up to 16 bytes can be written.
- As for page write cycle of BR24G32-3A and BR24G64-3A, after the significant 7 bits (in the case of BR24G32-3A) of word address, or the significant 8 bits (in the case of BR24G64-3A) of word address are designated arbitrarily, by continuing data input of 2 bytes or more, the address of insignificant 5 bits is incremented internally, and data up to 32 bytes can be written.
- As for page write cycle of BR24G128-3A and BR24G256-3A, after the significant 8 bits (in the case of BR24G128-3) of word address, or the significant 9 bits (in the case of BR24G256-3A) of word address are designated arbitrarily, by continuing data input of 2 bytes or more, the address of insignificant 6 bits is incremented internally, and data up to 64 bytes can be written.
- As for page write cycle of BR24G512-31 after the significant 9 bits of word address are designated arbitrarily, by continuing data input of 2 bytes or more, the address of insignificant 7 bits is incremented internally, and data up to 128 bytes can be written.
- As for page write cycle of BR24G1M-3A after page select bit 'P0' and the significant 8 bits of word address are designated arbitrarily, by continuing data input of 2 bytes or more, the address of insignificant 8 bits is incremented internally, and data up to 256 bytes can be written.



ONotes on page write cycle

List of numbers of page write

Number of Pages	8Byte	16Byte	32Byte	64Byte	128Byte	256Byte
Product number	BR24G01-3A BR24G02-3A	BR24G04-3A BR24G08-3A BR24G16-3A	BR24G32-3A BR24G64-3A	BR24G128-3A BR24G256-3A	BR24G512-3A	BR24G1M-3A

The above numbers are maximum bytes for respective types. Any bytes below these can be written.

In the case BR24G256-3A, 1 page=64bytes, but the page write cycle time is 5ms at maximum for 64byte bulk write. It does not stand 5ms at maximum × 64byte=320ms(Max.)

OInternal address increment

Page write mode (in the case of BR24G16-3A)



For example, when it is started from address 0Eh, therefore, increment is made as below, 0Eh-+0Fh-+00h-+01h++++ which please note.

%0Eh···0E in hexadecimal, therefore, 00001110 becomes a

OWrite protect (WP) terminal

Write protect (WP) function

When WP terminal is set Vcc (H level), data rewrite of all addresses is prohibited. When it is set GND (L level), data rewrite of all address is enabled. Be sure to connect this terminal to Vcc or GND, or control it to H level or L level. Do not use it open. In the case of use it as an ROM, it is recommended to connect it to pull up or Vcc.

binary number

At extremely low voltage at power ON / OFF, by setting the WP terminal 'H', mistake write can be prevented.

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Read Command

ORead cycle

Data of EEPROM is read. In read cycle, there are random read cycle and current read cycle.

Random read cycle is a command to read data by designating address, and is used generally.

Current read cycle is a command to read data of internal address register without designating address, and is used when to verify just after write cycle. In both the read cycles, sequential read cycle is available, and the next address data can be read in succession.



Fig.46 Sequential read cycle (in the case of current read cycle)

In random read cycle, data of designated word address can be read.

- When the command just/before-current read cycle is random read cycle, current read cycle (each including sequential read cycle), data of incremented last read address (n)-th address, i.e., data of the (n+1)-th address is output.
- When ACK signal LOW after D0 is detected, and stop condition is not sent from master (µ-COM) side, the next address data can be read in succession.
- · Read cycle is ended by stop condition where 'H' is input to ACK signal after D0 and SDA signal is started at SCL signal 'H' .
- . When 'H' is not input to ACK signal after D0, sequential read gets in, and the next data is output.
- Therefore, read command cycle cannot be ended. When to end read command cycle, be sure input stop condition to input 'H' to ACK signal after DQ, and to start SDA at SCL signal 'H'.
- · Sequential read is ended by stop condition where 'H' is input to ACK signal after arbitrary D0 and SDA is started at SCL signal 'H'.



- In BR24G16-3A, A2 becomes P2.
- In BR24G08/16-3A, A1 becomes P1. In BR24G08/16/1M-3A, A0 becomes P0. *2 *3

Fig.47 Difference of slave address of each type

Software reset

Software reset is executed when to avoid malfunction after power on, and to reset during command input. Software reset has several kinds, and 3 kinds of them are shown in the figure below. (Refer to Fig.45-(a), Fig.45-(b), Fig.45-(c).) In dummy clock input area, release the SDA bus ('H' by pull up). In dummy clock area, ACK output and read data '0' (both 'L' level) may be output from EEPROM, therefore, if 'H' is input forcibly, output may conflict and over current may flow, leading to instantaneous power failure of system power source or influence upon devices.



Acknowledge polling

During internal write execution, all input commands are ignored, therefore ACK is not sent back. During internal automatic write execution after write cycle input, next command (slave address) is sent, and if the first ACK signal sends back 'L', then it means end of write action, while if it sends back 'H', it means now in writing. By use of acknowledge polling, next command can be executed without waiting for tWR = 5ms.

When to write continuously, $R\overline{W} = 0$, when to carry out current read cycle after write, slave address $R\overline{W} = 1$ is sent, and if ACK signal sends back 'L', then execute word address input and data output and so forth.



Fig.49 Case to continuously write by acknowledge polling

•WP valid timing (write cancel)

WP is usually fixed to 'H' or 'L', but when WP is used to cancel write cycle and so forth, pay attention to the following WP valid timing. During write cycle execution, in cancel valid area, by setting WP='H', write cycle can be cancelled. In both byte write cycle and page write cycle, the area from the first start condition of command to the rise of clock to taken in D0 of data(in page write cycle, the first byte data) is cancel invalid area.

WP input in this area becomes Don't care. The area from the rise of SCL to take in D0 to input the stop condition is cancel valid area. And, after execution of forced end by WP, standby status gets in.



During command input, by continuously inputting start condition and stop condition, command can be cancelled. (Fig.51) However, in ACK output area and during data read, SDA bus may output 'L', and in this case, start condition and stop condition cannot be input, so reset is not available. Therefore, execute software reset. And when command is cancelled by start, stop condition, during random read cycle, sequential read cycle, or current read cycle, internal setting address is not determined, therefore, it is not possible to carry out current read cycle in succession. When to carry out read cycle in succession, carry out random read cycle.



●I/O peripheral circuit

OPull up resistance of SDA terminal

SDA is NMOS open drain, so requires pull up resistance. As for this resistance value (R_{PU}), select an appropriate value to this resistance value from microcontroller V_{IL} , I_L , and V_{OL} - I_{OL} characteristics of this IC. If R_{PU} is large, action frequency is limited. The smaller the R_{PU} , the larger the consumption current at action.

OMaximum value of RPU

The maximum value of R_{PU} is determined by the following factors.

()SDA rise time to be determined by the capacitance (CBUS) of bus line of R_{PU} and SDA should be tR or below.

And AC timing should be satisfied even when SDA rise time is late.

②The bus electric potential (A) to be determined by input leak total (I_L) of device connected to bus at output of 'H' to SDA bus and R_{PU} should sufficiently secure the input 'H' level (V_{H}) of microcontroller and EEPROM including recommended noise margin 0.2Vcc.

Vcc-ILRPU-0.2 Vcc \geq VIH

 $\therefore \quad \mathsf{RPU} \quad \leq \frac{0.8\mathsf{VCC} - \mathsf{VIH}}{\mathsf{IL}}$ BR24GXX Microcontroller Ex.) Vcc =3V IL=10µA VIH=0.7 Vcc from(2) SDA terminal $\mathsf{RPU} \leq \frac{0.8 \times 3 - 0.7 \times 3}{10 \times 10^{-6}}$ Iι ≦ 300 ⊮Ω] Bus line capacity O Minimum value of R_{PU} сву́s The minimum value of RPU is determined by the following factors. When IC outputs LOW, it should be satisfied that VOLMAX=0.4V and IgLMAX=3mA. Fig.52 VQ circuit diagram • • . .

$$\frac{VCC-VOL}{RPU} \leq IOL$$

$$\therefore$$
 RPU $\geq \frac{V_{CC} - V_{OL}}{I_{OL}}$

(2)Volmax= should secure the input 'L' level (V_{L}) of microcontroller and EEPROM including recommended noise margin 0.1Vcc. Volmax \leq VIL-0.1 Vcc

Ex.) Vcc =3V, VoL=0.4V, IoL=3mA, microcontroller, EEPROM VIL=0.3Vcc

from (1) RPU

And

VIL=0.3×3 =0.9 [V]

3 - 0.4

 3×10

≧ 867 ₽] Vol=0.4 [V]

Therefore, the condition (2) is satisfied.

OPull up resistance of SCL terminal

When SCL control is made at CMOS output port, there is no need, but in the case there is timing where SCL becomes 'Hi-Z', add a pull up resistance. As for the pull up resistance, one of several k Ω ~ several ten k Ω is recommended in consideration of drive performance of output port of microcontroller.

Cautions on microcontroller connection

ORs

In I²C BUS, it is recommended that SDA port is of open drain input/output. However, when using CMOS input / output of tri state to SDA port, insert a series resistance Rs between the pull up resistance Rpu and the SDA terminal of EEPROM. This controls over current that occurs when PMOS of the microcontroller and NMOS of EEPROM are turned ON simultaneously. Rs also plays the role of protection of SDA terminal against surge. Therefore, even when SDA port is open drain input/output, Rs can be used.



OMaximum value of Rs

The maximum value of Rs is determined by the following relations

- (ISDA rise time to be determined by the capacity (CBUS) of bus line of Rpu and SDA should be tR or below.
- And AC timing should be satisfied even when SDA rise time is late.
- 2The bus electric potential (A) to be determined by Rpu and Rs the moment when EEPROM outputs 'L' to SDA bus sufficiently secure the input 'L' level (VIL) of microcontroller including recommended noise margin 0.1Vcc.



OMinimum value of Rs

The minimum value of Rs is determined by over current at bus collision. When over current flows, noises in power source line, and instantarieous power failure of power source may occur. When allowable over current is defined as I, the following relation must be satisfied. Determine the allowable current in consideration of impedance of power source line in set and so forth. Set the over current to EEPROM 10mA or below.



$$\frac{Vcc}{Rs} \leq I$$

$$\therefore Rs \geq \frac{Vcc}{I}$$

Ex.) VCC=3V, I=10mA

$$Rs \geq \frac{3}{10 \times 10^{-3}}$$
$$\geq 300[0]$$

Fig

●I²C BUS input / output circuit

OInput (A0, A1, A2, SCL, WP)



BR24G

•Notes on power ON

At power on, in IC internal circuit and set, Vcc rises through unstable low voltage area, and IC inside is not completely reset, and malfunction may occur. To prevent this, functions of POR circuit and LVCC circuit are equipped. To assure the action, observe the following conditions at power on.

- 1. Set SDA = 'H' and SCL ='L' or 'H'
- 2. Start power source so as to satisfy the recommended conditions of t_R, t_{OFF}, and Vbot for operating POR circuit.



(3) Absolute maximum ratings

If the absolute maximum ratings such as impressed voltage and action temperature range and so forth are exceeded, LSI may be destructed. Do not impress voltage and temperature exceeding the absolute maximum ratings. In the case of fear exceeding the absolute maximum ratings, take physical safety countermeasures such as fuses, and see to it that conditions exceeding the absolute maximum ratings should not be impressed to LSI.

- (4) GND electric potential Set the voltage of GND terminal lowest at any action condition. Make sure that each terminal voltage is lower than that of GND terminal.
- (5) Terminal design

In consideration of permissible loss in actual use condition, carry out heat design with sufficient margin.

(6) Terminal to terminal shortcircuit and wrong packaging

When to package LSI onto a board, pay sufficient attention to LSI direction and displacement. Wrong packaging may destruct LSI. And in the case of shortcircuit between LSI terminals and terminals and power source, terminal and GND owing to foreign matter, LSI may be destructed.

(7) Use in a strong electromagnetic field may cause malfunction, therefore, evaluate design sufficiently.





VSON008X2030

